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#### Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	2MHz
Connectivity	-
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	16-DIP (0.300", 7.62mm)
Supplier Device Package	16-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mchlc908qy4pe

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#### Input/Output (I/O) Section

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$001F	Configuration Register 1 (CONFIG1) <sup>(1)</sup>	Read: Write:	COPRS	LVISTOP	LVIRSTD	LVIPWRD	LVDLVR	SSREC	STOP	COPD
See page 54.		Reset:	0	0	0	0	0 <sup>(2)</sup>	0	0	0
<ol> <li>One-time writable register after each reset. Exceptions are LVDLVR and LVIRSTD bits.</li> <li>LVDLVR reset to 0 by a power-on reset (POR) only.</li> </ol>										
	TIM Status and Control	Read:	TOF	TOIL	TOTOD	0	0	DCO	DC1	DCO
\$0020	Register (TSC)	Write:	0	TOIE	1310P	TRST		F 72	P51	P50
	See page 127.	Reset:	0	0	1	0	0	0	0	0
	TIM Counter Register High	Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
\$0021	(TCNTH)	Write:								
	See page 129.	Reset:	0	0	0	0	0	0	0	0
	TIM Counter Register Low	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0022	(TCNTL)	Write:								
	See page 129.	Reset:	0	0	0	0	0	0	0	0
TIM Counter Moo \$0023 Register High (TMO	TIM Counter Modulo	Read:	Bit 15	Bit 1/	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
	Register High (TMODH)	Write:	Dit 15	Dit 14	Dit 10	DICTZ	Dit H	Dit 10	Dit 3	Ditto
	See page 129.	Reset:	1	1	1	1	1	1	1	1
	TIM Counter Modulo	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0024	Register Low (TMODL)	Write:	BRT	Dir o	Bito	DRT	Diro	DICE	Dit i	Dir o
See page	See page 129.	Reset:	1	1	1	1	1	1	1	1
	TIM Channel 0 Status and	Read:	CH0F	CHOIE	MS0B	MS0A	ELS0B	ELS0A	TOVO	CHOMAX
\$0025	Control Register (TSC0)	Write:	0	0.1012						0.101.00
	See page 130.	Reset:	0	0	0	0	0	0	0	0
	TIM Channel 0	Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
\$0026	Register High (TCH0H)	Write:								
	Oee page 105.	Reset:		1	1	Indetermina	te after reset		r	1
\$0027	TIM Channel 0	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	Register Low (TCH0L)	Write:								
	000 pago 100.	Reset:	Indeterminate after reset					1		
TIM Ch	TIM Channel 1 Status and	Read:	CH1F	CH1IE	0	MS1A	ELS1B	ELS1A	TOV1	CH1MAX
\$0028	Control Register (TSC1) See page 130.	Write:	0						<u> </u>	
	500 page 100.	Reset:	0	0	0	0	0	0	0	0
			= Unimplemented		R	= Reserved	U = Unaf	lected		

Figure 2-2. Control, Status, and Data Registers (Sheet 3 of 6)



- 8. Wait for time,  $t_{PROG}$  (minimum 30  $\mu$ s).
- 9. Repeat step 7 and 8 until all desired bytes within the row are programmed.
- 10. Clear the PGM bit $^{(1)}$ .
- 11. Wait for time,  $t_{NVH}$  (minimum 5  $\mu$ s).
- 12. Clear the HVEN bit.
- 13. After time,  $t_{RCV}$  (typical 1 µs), the memory can be accessed in read mode again.

#### NOTE

The COP register at location \$FFFF should not be written between steps 5-12, when the HVEN bit is set. Since this register is located at a valid FLASH address, unpredictable behavior may occur if this location is written while HVEN is set.

This program sequence is repeated throughout the memory until all data is programmed.

#### NOTE

Programming and erasing of FLASH locations cannot be performed by code being executed from the FLASH memory. While these operations must be performed in the order shown, other unrelated operations may occur between the steps. Do not exceed  $t_{PROG}$  maximum, see 16.12 Memory Characteristics.

### 2.6.5 FLASH Protection

Due to the ability of the on-board charge pump to erase and program the FLASH memory in the target application, provision is made to protect blocks of memory from unintentional erase or program operations due to system malfunction. This protection is done by use of a FLASH block protect register (FLBPR). The FLBPR determines the range of the FLASH memory which is to be protected. The range of the protected area starts from a location defined by FLBPR and ends to the bottom of the FLASH memory (\$FFFF). When the memory is protected, the HVEN bit cannot be set in either ERASE or PROGRAM operations.

#### NOTE

In performing a program or erase operation, the FLASH block protect register must be read after setting the PGM or ERASE bit and before asserting the HVEN bit.

When the FLBPR is programmed with all 0s, the entire memory is protected from being programmed and erased. When all the bits are erased (all 1s), the entire memory is accessible for program and erase.

When bits within the FLBPR are programmed, they lock a block of memory. The address ranges are shown in 2.6.6 FLASH Block Protect Register. Once the FLBPR is programmed with a value other than FF, any erase or program of the FLBPR or the protected block of FLASH memory is prohibited. Mass erase is disabled whenever any block is protected (FLBPR does not equal FF). The FLBPR itself can be erased or programmed only with an external voltage,  $V_{TST}$ , present on the IRQ pin. This voltage also allows entry from reset into the monitor mode.



#### Analog-to-Digital Converter (ADC)

### CH[4:0] — ADC Channel Select Bits

CH4, CH3, CH2, CH1, and CH0 form a 5-bit field which is used to select one of the four ADC channels. The five select bits are detailed in Table 3-1. Care should be taken when using a port pin as both an analog and a digital input simultaneously to prevent switching noise from corrupting the analog signal. The ADC subsystem is turned off when the channel select bits are all set to 1. This feature allows for reduced power consumption for the MCU when the ADC is not used. Reset sets all of these bits to a 1.

### NOTE

Recovery from the disabled state requires one conversion cycle to stabilize.

CH4	СНЗ	CH2	CH1	CH0	ADC Channel	Input Select
0	0	0	0	0	AD0	PTA0
0	0	0	0	1	AD1	PTA1
0	0	0	1	0	AD2	PTA4
0	0	0	1	1	AD3	PTA5
0	0	1	0	0	_	
$\downarrow$	$\downarrow$	$\downarrow$	$\downarrow$	$\downarrow$	_	Unused <sup>(1)</sup>
1	1	0	1	0	_	
1	1	0	1	1	_	Reserved
1	1	1	0	0	_	Unused
1	1	1	0	1	_	V <sub>DDA</sub> <sup>(2)</sup>
1	1	1	1	0	_	V <sub>SSA</sub> <sup>(2)</sup>
1	1	1	1	1	—	ADC power off

Table 3-1.	MUX	Channel	Select
	1110/	<b>O</b> Hullion	001001

1. If any unused channels are selected, the resulting ADC conversion will be unknown.

The voltage levels supplied from internal reference nodes, as specified in the table, are used to verify the operation of the ADC converter both in production test and for user applications.

## 3.7.2 ADC Data Register

One 8-bit result register is provided. This register is updated each time an ADC conversion completes.



Figure 3-4. ADC Data Register (ADR)



#### Auto Wakeup Module (AWU)



Figure 4-1. Auto Wakeup Interrupt Request Generation Logic

The overflow count can be selected from two options defined by the COPRS bit in CONFIG1. This bit was "borrowed" from the computer operating properly (COP) using the fact that the COP feature is idle (no MCU clock available) in stop mode. The typical values of the periodic wakeup request are (at room temperature):

- COPRS = 0: 875 ms @ 3.0 V, 1.1 s @ 2.3 V
- COPRS = 1: 22 ms @ 3.0 V, 27 ms @ 2.3 V

The auto wakeup RC oscillator is highly dependent on operating voltage and temperature. This feature is not recommended for use as a time-keeping function.

The wakeup request is latched to allow the interrupt source identification. The latched value, AWUL, can be read directly from the bit 6 position of PTA data register. This is a read-only bit which is occupying an empty bit position on PTA. No PTA associated registers, such as PTA6 data, PTA6 direction, and PTA6 pullup exist for this bit. The latch can be cleared by writing to the ACKK bit in the KBSCR register. Reset also clears the latch. AWUIE bit in KBI interrupt enable register (see Figure 4-1) has no effect on AWUL reading.

The AWU oscillator and counters are inactive in normal operating mode and become active only upon entering stop mode.





# 6.3.7 COPRS (COP Rate Select)

The COPRS signal reflects the state of the COP rate select bit (COPRS) in the configuration register 1 (CONFIG1). See Chapter 5 Configuration Register (CONFIG).

# 6.4 COP Control Register

The COP control register (COPCTL) is located at address \$FFFF and overlaps the reset vector. Writing any value to \$FFFF clears the COP counter and starts a new timeout period. Reading location \$FFFF returns the low byte of the reset vector.



Figure 6-2. COP Control Register (COPCTL)

# 6.5 Interrupts

The COP does not generate CPU interrupt requests.

# 6.6 Monitor Mode

The COP is disabled in monitor mode when  $V_{TST}$  is present on the IRQ pin.

# 6.7 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power-consumption standby modes.

## 6.7.1 Wait Mode

The COP continues to operate during wait mode. To prevent a COP reset during wait mode, periodically clear the COP counter.

# 6.7.2 Stop Mode

Stop mode turns off the BUSCLKX4 input to the COP and clears the SIM counter. Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

# 6.8 COP Module During Break Mode

The COP is disabled during a break interrupt with monitor mode when BDCOP bit is set in break auxiliary register (BRKAR).



# Chapter 9 Keyboard Interrupt Module (KBI)

# 9.1 Introduction

The keyboard interrupt module (KBI) provides six independently maskable external interrupts, which are accessible via the PTA0–PTA5 pins.

# 9.2 Features

Features of the keyboard interrupt module include:

- Six keyboard interrupt pins with separate keyboard interrupt enable bits and one keyboard interrupt mask
- Software configurable pullup device if input pin is configured as input port bit
- Programmable edge-only or edge and level interrupt sensitivity
- Exit from low-power modes

# 9.3 Functional Description

The keyboard interrupt module controls the enabling/disabling of interrupt functions on the six port A pins. These six pins can be enabled/disabled independently of each other.

# 9.3.1 Keyboard Operation

Writing to the KBIE0–KBIE5 bits in the keyboard interrupt enable register (KBIER) independently enables or disables each port A pin as a keyboard interrupt pin. Enabling a keyboard interrupt pin in port A also enables its internal pullup device irrespective of PTAPUEx bits in the port A input pullup enable register (see 12.2.3 Port A Input Pullup Enable Register). A logic 0 applied to an enabled keyboard interrupt pin latches a keyboard interrupt request.

A keyboard interrupt is latched when one or more keyboard interrupt inputs goes low after all were high. The MODEK bit in the keyboard status and control register controls the triggering mode of the keyboard interrupt.

- If the keyboard interrupt is edge-sensitive only, a falling edge on a keyboard interrupt input does not latch an interrupt request if another keyboard pin is already low. To prevent losing an interrupt request on one input because another input is still low, software can disable the latter input while it is low.
- If the keyboard interrupt is falling edge and low-level sensitive, an interrupt request is present as long as any keyboard interrupt input is low.



#### **Functional Description**



### Figure 9-2. Keyboard Interrupt Block Diagram

If the MODEK bit is set, the keyboard interrupt inputs are both falling edge and low-level sensitive, and both of the following actions must occur to clear a keyboard interrupt request:

- Vector fetch or software clear A vector fetch generates an interrupt acknowledge signal to clear the interrupt request. Software may generate the interrupt acknowledge signal by writing a 1 to the ACKK bit in the keyboard status and control register (KBSCR). The ACKK bit is useful in applications that poll the keyboard interrupt inputs and require software to clear the keyboard interrupt request. Writing to the ACKK bit prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACKK does not affect subsequent transitions on the keyboard interrupt inputs. A falling edge that occurs after writing to the ACKK bit latches another interrupt request. If the keyboard interrupt mask bit, IMASKK, is clear, the central processor unit (CPU) loads the program counter with the vector address at locations \$FFE0 and \$FFE1.
- Return of all enabled keyboard interrupt inputs to logic 1 As long as any enabled keyboard interrupt pin is at logic 0, the keyboard interrupt remains set. The auto wakeup interrupt input, AWUIREQ, will be cleared only by writing to ACKK bit in KBSCR or reset.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to logic 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt input stays at logic 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.



# 9.7 Input/Output Registers

The following I/O registers control and monitor operation of the keyboard interrupt module:

- Keyboard interrupt status and control register (KBSCR)
- Keyboard interrupt enable register (KBIER)

### 9.7.1 Keyboard Status and Control Register

The keyboard status and control register (KBSCR):

- Flags keyboard interrupt requests
- Acknowledges keyboard interrupt requests
- Masks keyboard interrupt requests
- Controls keyboard interrupt triggering sensitivity



### Figure 9-3. Keyboard Status and Control Register (KBSCR)

#### Bits 7-4 — Not used

These read-only bits always read as 0s.

#### KEYF — Keyboard Flag Bit

This read-only bit is set when a keyboard interrupt is pending on port A or auto wakeup. Reset clears the KEYF bit.

1 = Keyboard interrupt pending

0 = No keyboard interrupt pending

#### ACKK — Keyboard Acknowledge Bit

Writing a 1 to this write-only bit clears the keyboard interrupt request on port A and auto wakeup logic. ACKK always reads as 0. Reset clears ACKK.

#### IMASKK— Keyboard Interrupt Mask Bit

Writing a 1 to this read/write bit prevents the output of the keyboard interrupt mask from generating interrupt requests on port A or auto wakeup. Reset clears the IMASKK bit.

1 = Keyboard interrupt requests masked

0 = Keyboard interrupt requests not masked

#### MODEK — Keyboard Triggering Sensitivity Bit

This read/write bit controls the triggering sensitivity of the keyboard interrupt pins on port A and auto wakeup. Reset clears MODEK.

1 = Keyboard interrupt requests on falling edges and low levels

0 = Keyboard interrupt requests on falling edges only



Oscillator Module (OSC)

# 11.3.3 XTAL Oscillator

The XTAL oscillator circuit is designed for use with an external low-frequency crystal or ceramic resonator to provide an accurate clock source. In this configuration, the OSC2 pin is dedicated to the external crystal circuit. The OSC2EN bit in the port A pullup enable register has no effect when this clock mode is selected.

In its typical configuration, the XTAL oscillator is connected in a Pierce oscillator configuration, as shown in Figure 11-2. This figure shows only the logical representation of the internal components and may not represent actual circuitry. The oscillator configuration uses five components:

- Crystal, X<sub>1</sub>
- Fixed capacitor, C<sub>1</sub>
- Tuning capacitor, C<sub>2</sub> (can also be a fixed capacitor)
- Feedback resistor, R<sub>B</sub>
- Series resistor, R<sub>s</sub>



Figure 11-2. XTAL Oscillator External Connections

## 11.3.4 RC Oscillator

The RC oscillator circuit is designed for use with an external resistor ( $R_{EXT}$ ) to provide a clock source with a tolerance within 25% of the expected frequency. See Figure 11-3.

The capacitor (C) for the RC oscillator is internal to the MCU. The R<sub>EXT</sub> value must have a tolerance of 1% or less to minimize its effect on the frequency.

In this configuration, the OSC2 pin can be left in the reset state as PTA4. Or, the OSC2EN bit in the port A pullup enable register can be set to enable the OSC2 output function on the pin. Enabling the OSC2 output slightly increases the external RC oscillator frequency, f<sub>RCCLK</sub>.



# 11.6 Oscillator During Break Mode

The oscillator continues to drive BUSCLKX2 and BUSCLKX4 when the device enters the break state.

# 11.7 CONFIG2 Options

Two CONFIG2 register options affect the operation of the oscillator module: OSCOPT1 and OSCOPT0. All CONFIG2 register bits will have a default configuration. Refer to Chapter 5 Configuration Register (CONFIG) for more information on how the CONFIG2 register is used.

Table 11-2 shows how the OSCOPT bits are used to select the oscillator clock source.

OSCOPT1	OSCOPT0	Oscillator Modes		
0	0	Internal Oscillator		
0	1	External Oscillator		
1	0	External RC		
1	1	External Crystal		

Table 11-2. Oscillator Modes

# 11.8 Input/Output (I/O) Registers

The oscillator module contains these two registers:

- 1. Oscillator status register (OSCSTAT)
- 2. Oscillator trim register (OSCTRIM)

## 11.8.1 Oscillator Status Register

The oscillator status register (OSCSTAT) contains the bits for switching from internal to external clock sources.





### ECGON — External Clock Generator On Bit

This read/write bit enables external clock generator, so that the switching process can be initiated. This bit is forced low during reset. This bit is ignored in monitor mode with the internal oscillator bypassed.

1 = External clock generator enabled

0 = External clock generator disabled

#### ECGST — External Clock Status Bit

This read-only bit indicates whether or not an external clock source is engaged to drive the system clock.

1 = An external clock source engaged

0 = An external clock source disengaged



# Chapter 12 Input/Output Ports (PORTS)

# 12.1 Introduction

The MC68HLC908QT1, MC68HLC908QT2, and MC68HLC908QT4 have five bidirectional input-output (I/O) pins and one input only pin. The MC68HLC908QY1, MC68HLC908QY2, and MC68HLC908QY4 have thirteen bidirectional pins and one input only pin. All I/O pins are programmable as inputs or outputs.

### NOTE

Connect any unused I/O pins to an appropriate logic level, either  $V_{DD}$  or  $V_{SS}$ . Although the I/O ports do not require termination for proper operation, termination reduces excess current consumption and the possibility of electrostatic damage.

8-pin devices have non-bonded pins. These pins should be configured either as outputs driving low or high, or as inputs with internal pullups enabled. Configuring these non-bonded pins in this manner will prevent any excess current consumption caused by floating inputs.

# 12.2 Port A

Port A is a 6-bit special function port that shares all six of its pins with the keyboard interrupt (KBI) module (see Chapter 9 Keyboard Interrupt Module (KBI)). Each port A pin also has a software configurable pullup device if the corresponding port pin is configured as an input port.

### NOTE

## PTA2 is input only.

When the IRQ function is enabled in the configuration register 2 (CONFIG2), bit 2 of the port A data register (PTA) will always read a 0. In this case, the BIH and BIL instructions can be used to read the logic level on the PTA2 pin. When the IRQ function is disabled, these instructions will behave as if the PTA2 pin is a logic 1. However, reading bit 2 of PTA will read the actual logic level on the pin.



# Chapter 13 System Integration Module (SIM)

# **13.1 Introduction**

This section describes the system integration module (SIM), which supports up to 24 external and/or internal interrupts. Together with the central processor unit (CPU), the SIM controls all microcontroller unit (MCU) activities. A block diagram of the SIM is shown in Figure 13-1. The SIM is a system state controller that coordinates CPU and exception timing.

The SIM is responsible for:

- · Bus clock generation and control for CPU and peripherals
  - Stop/wait/reset/break entry and recovery
  - Internal clock control
- Master reset control, including power-on reset (POR) and computer operating properly (COP) timeout
- Interrupt control:
  - Acknowledge timing
  - Arbitration control timing
  - Vector address generation
- CPU enable/disable timing

# 13.2 RST and IRQ Pins Initialization

RST and IRQ pins come out of reset as PTA3 and PTA2 respectively. RST and IRQ functions can be activated by programing CONFIG2 accordingly. Refer to Chapter 5 Configuration Register (CONFIG).

Signal Name	Description
BUSCLKX4	Buffered clock from the internal, RC or XTAL oscillator circuit.
BUSCLKX2	The BUSCLKX4 frequency divided by two. This signal is again divided by two in the SIM to generate the internal bus clocks (bus clock = BUSCLKX4 $\div$ 4).
Address bus	Internal address bus
Data bus	Internal data bus
PORRST	Signal from the power-on reset module to the SIM
IRST	Internal reset signal
R/W	Read/write signal

Table 13-1. Signal Name Conventions



#### System Integration Module (SIM)



Figure 13-1. SIM Block Diagram

# **13.3 SIM Bus Clock Control and Generation**

The bus clock generator provides system clock signals for the CPU and peripherals on the MCU. The system clocks are generated from an incoming clock, BUSCLKX2, as shown in Figure 13-2.



Figure 13-2. SIM Clock Signals

#### **Timer Interface Module (TIM)**



RST, IRQ: Pins have internal (about 30K Ohms) pull up

PTA[0:5]: High current sink and source capability

PTA[0:5]: Pins have programmable keyboard interrupt and pull up

PTB[0:7]: Not available on 8-pin devices – MC68HLC908QT1, MC68HLC908QT2, and MC68HLC908QT4 (see note in 12.1 Introduction)

ADC: Not available on the MC68HLC908QY1 and MC68HC9L08QT1

### Figure 14-1. Block Diagram Highlighting TIM Block and Pins



Setting MS0B disables the channel 1 status and control register and reverts TCH1 to general-purpose I/O.

Reset clears the MSxB bit.

- 1 = Buffered output compare/PWM operation enabled
- 0 = Buffered output compare/PWM operation disabled

## MSxA — Mode Select Bit A

When ELSxB:A  $\neq$  00, this read/write bit selects either input capture operation or unbuffered output compare/PWM operation.

### See Table 14-3.

- 1 = Unbuffered output compare/PWM operation
- 0 = Input capture operation

When ELSxB:A = 00, this read/write bit selects the initial output level of the TCHx pin (see Table 14-3). Reset clears the MSxA bit.

1 = Initial output level low

0 = Initial output level high

### NOTE

Before changing a channel function by writing to the MSxB or MSxA bit, set the TSTOP and TRST bits in the TIM status and control register (TSC).

MSxB	MSxA	ELSxB	ELSxA	Mode	Configuration
Х	0	0	0		Pin under port control; initial output level high
Х	1	0	0	Oulput preset	Pin under port control; initial output level low
0	0	0	1		Capture on rising edge only
0	0	1	0	Input capture	Capture on falling edge only
0	0	1	1		Capture on rising or falling edge
0	1	0	0	Output compare	Software compare only
0	1	0	1		Toggle output on compare
0	1	1	0	or PWM	Clear output on compare
0	1	1	1		Set output on compare
1	Х	0	1	Buffered output	Toggle output on compare
1	Х	1	0	compare or	Clear output on compare
1	Х	1	1	buffered PWM	Set output on compare

### Table 14-3. Mode, Edge, and Level Selection

### ELSxB and ELSxA — Edge/Level Select Bits

When channel x is an input capture channel, these read/write bits control the active edge-sensing logic on channel x.

When channel x is an output compare channel, ELSxB and ELSxA control the channel x output behavior when an output compare occurs.



#### Monitor Module (MON)



Figure 15-9. Simplified Monitor Mode Entry Flowchart



Development Support



### Table 15-4. WRITE (Write Memory) Command





### Table 15-6. IWRITE (Indexed Write) Command



A sequence of IREAD or IWRITE commands can access a block of memory sequentially over the full 64-Kbyte memory map.



**Electrical Specifications** 





DETAIL "D"

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